



### Dimensions

Footprint	6032
L	6mm +/-0.3mm
W	3.2mm +/-0.3mm
H	1.5mm MAX
S	1.3mm +/-0.3mm
F	2.2mm +/-0.1mm
K	1.3mm TYP

### Packaging Specifications

Packaging	T&R, 330mm
Packaging Quantity	4750

### General Information

Dielectric	MnO <sub>2</sub> Tantalum
Style	SMD Chip
Description	SMD, Molded, Low Profile, Low ESR, Surge Robust
Features	Low Profile, Low ESR, Surge Robust
RoHS	Yes
Termination	Tin
AEC-Q200	No
Notes	Obsolete. Old Part Number [Obsolete] Was B45192R3336M306.

### Specifications

Capacitance	33 uF
Capacitance Tolerance	20%
Voltage DC	16 VDC (85C), 10.72 VDC (125C)
Temperature Range	-55/+125°C
Rated Temperature	85°C
Dissipation Factor	6%
Failure Rate	N/A
ESR	0.4 Ohms (100kHz)
Ripple Current	470 mAmps (25C), 423 mAmps (85C), 188 mAmps (125C)
Leakage Current	5.3 uA